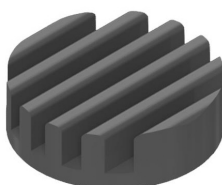


Data sheet Product ICK LED R 33 x 10

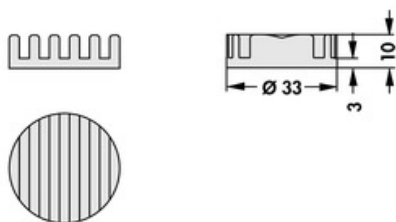


Heatsinks and active heatsinks for processors>Heatsinks for LEDs
Ø 33 x 10 mm, for IC design LED

Features

diameter:	33 mm
way of fixation:	• therm. conductive foil • therm. cond. adhesive
height:	10 mm
plate thickness:	3 mm
thermal resistance:	17.6 K/W
dissipation loss:	6.8 W
surface:	black anodised

Technical Drawing



$$R_{th} = 17,6 \text{ K/W}$$